

## LP2985 150-mA Low-noise Low-dropout Regulator With Shutdown

### 1 Features

- Output Tolerance of
  - 1% (A Grade)
  - 1.5% (Standard Grade)
- Ultra-Low Dropout, Typically
  - 280 mV at Full Load of 150 mA
  - 7 mV at 1 mA
- Wide  $V_{IN}$  Range: 16 V Max
- Low  $I_Q$ : 850  $\mu$ A at Full Load at 150 mA
- Shutdown Current: 0.01  $\mu$ A Typ
- Low Noise: 30  $\mu$ V<sub>RMS</sub> With 10-nF Bypass Capacitor
- Stable With Low-ESR Capacitors, Including Ceramic
- Overcurrent and Thermal Protection
- High Peak-Current Capability
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)

### 2 Applications

- Portable Devices
- Digital Cameras and Camcorders
- CD Players
- MP3 Players

### 3 Description

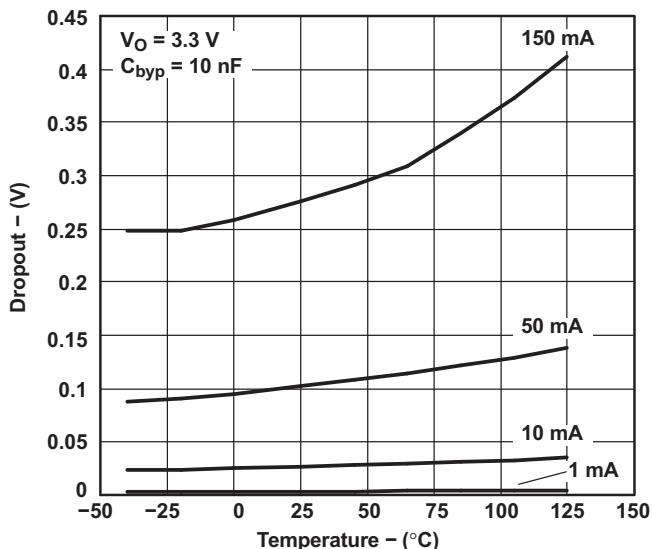
The LP2985 family of fixed-output, low-dropout regulators offers exceptional, cost-effective performance for both portable and nonportable applications. Available in voltages of 1.8 V, 2.5 V, 2.8 V, 2.9 V, 3 V, 3.1 V, 3.3 V, 5 V, and 10 V, the family has an output tolerance of 1% for the A version (1.5% for the non-A version) and is capable of delivering 150-mA continuous load current. Standard regulator features, such as overcurrent and overtemperature protection, are included.

#### Device Information<sup>(1)</sup>

PART NUMBER	PACKAGE	BODY SIZE (NOM)
LP2985	SOT-23 (5)	2.90 mm x 1.60 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

#### Dropout Voltage vs Temperature



An IMPORTANT NOTICE at the end of this data sheet addresses availability, warranty, changes, use in safety-critical applications, intellectual property matters and other important disclaimers. PRODUCTION DATA.

## Table of Contents

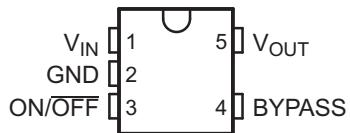
<b>1 Features .....</b>	<b>1</b>	<b>7.2 Functional Block Diagram .....</b>	<b>11</b>
<b>2 Applications .....</b>	<b>1</b>	<b>7.3 Feature Description.....</b>	<b>11</b>
<b>3 Description .....</b>	<b>1</b>	<b>7.4 Device Functional Modes.....</b>	<b>11</b>
<b>4 Revision History.....</b>	<b>2</b>	<b>8 Application and Implementation .....</b>	<b>12</b>
<b>5 Pin Configuration and Functions .....</b>	<b>3</b>	<b>8.1 Application Information.....</b>	<b>12</b>
<b>6 Specifications.....</b>	<b>4</b>	<b>9 Power Supply Recommendations .....</b>	<b>16</b>
6.1 Absolute Maximum Ratings .....	4	<b>10 Layout.....</b>	<b>17</b>
6.2 ESD Ratings.....	4	10.1 Layout Guidelines .....	17
6.3 Recommended Operating Conditions.....	4	10.2 Layout Example .....	17
6.4 Thermal Information .....	4	<b>11 Device and Documentation Support .....</b>	<b>17</b>
6.5 Electrical Characteristics.....	5	11.1 Trademarks .....	17
6.6 Typical Characteristics .....	7	11.2 Electrostatic Discharge Caution .....	17
<b>7 Detailed Description .....</b>	<b>11</b>	11.3 Glossary .....	17
7.1 Overview .....	11	<b>12 Mechanical, Packaging, and Orderable</b>	
		<b>Information .....</b>	<b>17</b>

## 4 Revision History

Changes from Revision N (June 2011) to Revision O	Page
• Added <i>Applications</i> , <i>Device Information</i> table, <i>Pin Functions</i> table, <i>ESD Ratings</i> table, <i>Thermal Information</i> table, <i>Feature Description</i> section, <i>Device Functional Modes</i> , <i>Application and Implementation</i> section, <i>Power Supply Recommendations</i> section, <i>Layout</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section.	1
• Deleted <i>Ordering Information</i> table.	1

## 5 Pin Configuration and Functions

**DBV (SOT-23) PACKAGE  
(TOP VIEW)**



### Pin Functions

<b>PIN</b>		<b>TYPE</b>	<b>DESCRIPTION</b>
<b>NAME</b>	<b>NO.</b>		
BYPASS	4	I/O	Attach a 10-nF capacitor to improve low-noise performance.
GND	2	—	Ground
ON/OFF	3	I	Active-low shutdown pin. Tie to $V_{IN}$ if unused.
$V_{IN}$	1	I	Supply input
$V_{OUT}$	5	O	Voltage output

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over virtual junction temperature range (unless otherwise noted)<sup>(1)</sup>

		MIN	MAX	UNIT
V <sub>IN</sub>	Continuous input voltage range <sup>(2)</sup>	-0.3	16	V
V <sub>ON/ OFF</sub>	ON/OFF input voltage range	-0.3	16	V
	Output voltage range <sup>(3)</sup>	-0.3	9	V
I <sub>O</sub>	Output current <sup>(4)</sup>	Internally limited (short-circuit protected)		—
θ <sub>JA</sub>	Package thermal impedance <sup>(4) (5)</sup>			206 °C/W
T <sub>J</sub>	Operating virtual junction temperature			150 °C
T <sub>stg</sub>	Storage temperature range	-65	150	°C

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The PNP pass transistor has a parasitic diode connected between the input and output. This diode normally is reverse biased (V<sub>IN</sub> > V<sub>OUT</sub>), but will be forward biased if the output voltage exceeds the input voltage by a diode drop (see *Application Information* for more details).
- (3) If load is returned to a negative power supply in a dual-supply system, the output must be diode clamped to GND.
- (4) Maximum power dissipation is a function of T<sub>J(max)</sub>, θ<sub>JA</sub>, and T<sub>A</sub>. The maximum allowable power dissipation at any allowable ambient temperature is P<sub>D</sub> = (T<sub>J(max)</sub> – T<sub>A</sub>)/θ<sub>JA</sub>. Operating at the absolute maximum T<sub>J</sub> of 150°C can affect reliability.
- (5) The package thermal impedance is calculated in accordance with JESD 51-7.

### 6.2 ESD Ratings

		VALUE	UNIT
V <sub>(ESD)</sub>	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>	2000
		Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup>	1000

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

		MIN	MAX	UNIT
V <sub>IN</sub>	Supply input voltage	2.2 <sup>(1)</sup>	16	V
V <sub>ON/ OFF</sub>	ON/OFF input voltage	0	V <sub>IN</sub>	V
I <sub>OUT</sub>	Output current			150 mA
T <sub>J</sub>	Virtual junction temperature	-40	125	°C

- (1) Recommended minimum V<sub>IN</sub> is the greater of 2.5 V or V<sub>OUT(max)</sub> + rated dropout voltage (max) for operating I<sub>L</sub>.

### 6.4 Thermal Information

THERMAL METRIC <sup>(1)</sup>	LP2985	UNIT
	DBV	
	5 PINS	
R <sub>θJA</sub>	Junction-to-ambient thermal resistance	206 °C/W

- (1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).

## 6.5 Electrical Characteristics

at specified virtual junction temperature range,  $V_{IN} = V_{OUT(NOM)} + 1\text{ V}$ ,  $V_{ON/\overline{OFF}} = 2\text{ V}$ ,  $C_{IN} = 1\text{ }\mu\text{F}$ ,  $I_L = 1\text{ mA}$ ,  $C_{OUT} = 4.7\text{ }\mu\text{F}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS	$T_J$	LP2985A-xx			LP2985-xx			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
$\Delta V_{OUT}$	Output voltage tolerance	$I_L = 1\text{ mA}$	25°C	-1	1	-1.5	1.5	1.5	%/ $V_{NOM}$
		$1\text{ mA} \leq I_L \leq 50\text{ mA}$	25°C	-1.5	1.5	-2.5	2.5	2.5	
		$-40^\circ\text{C} \text{ to } 125^\circ\text{C}$	-2.5	2.5	-3.5	3.5	3.5	3.5	
		$1\text{ mA} \leq I_L \leq 150\text{ mA}$	25°C	-2.5	2.5	-3	3	4	
	Line regulation	$25^\circ\text{C}$	0.007	0.014	0.007	0.014	0.007	0.014	
		$-40^\circ\text{C} \text{ to } 125^\circ\text{C}$		0.032			0.032		
		$25^\circ\text{C}$	0.007	0.014	0.007	0.014	0.007	0.014	
		$-40^\circ\text{C} \text{ to } 125^\circ\text{C}$		0.032			0.032		
$V_{IN} - V_{OUT}$	Dropout voltage <sup>(1)</sup>	$I_L = 0$	25°C	1	3	1	3	1	mV
			$-40^\circ\text{C} \text{ to } 125^\circ\text{C}$		5		5		
		$I_L = 1\text{ mA}$	25°C	7	10	7	10	7	
			$-40^\circ\text{C} \text{ to } 125^\circ\text{C}$		15		15		
		$I_L = 10\text{ mA}$	25°C	40	60	40	60	40	
			$-40^\circ\text{C} \text{ to } 125^\circ\text{C}$		90		90		
		$I_L = 50\text{ mA}$	25°C	120	150	120	150	120	
			$-40^\circ\text{C} \text{ to } 125^\circ\text{C}$		225		225		
		$I_L = 150\text{ mA}$	25°C	280	350	280	350	280	
			$-40^\circ\text{C} \text{ to } 125^\circ\text{C}$		575		575		
$I_{GND}$	GND pin current	$I_L = 0$	25°C	65	95	65	95	65	\mu A
			$25^\circ\text{C}$ (LP2985-10)		125		125		
			$-40^\circ\text{C} \text{ to } 125^\circ\text{C}$		125		125		
			$-40^\circ\text{C} \text{ to } 125^\circ\text{C}$ (LP2985-10)		160		160		
		$I_L = 1\text{ mA}$	25°C	75	110	75	110	75	
			$25^\circ\text{C}$ (LP2985-10)		140		140		
			$-40^\circ\text{C} \text{ to } 125^\circ\text{C}$		170		170		
		$I_L = 10\text{ mA}$	25°C	120	220	120	220	120	
			$25^\circ\text{C}$ (LP2985-10)		250		250		
			$-40^\circ\text{C} \text{ to } 125^\circ\text{C}$		400		400		
		$I_L = 50\text{ mA}$	25°C	350	600	350	600	350	
			$25^\circ\text{C}$ (LP2985-10)		650		650		
			$-40^\circ\text{C} \text{ to } 125^\circ\text{C}$		1000		1000		
		$I_L = 150\text{ mA}$	25°C	850	1500	850	1500	850	
			$25^\circ\text{C}$ (LP2985-10)		1800		1800		
			$-40^\circ\text{C} \text{ to } 125^\circ\text{C}$		2500		2500		
		$V_{ON/\overline{OFF}} < 0.3\text{ V}$ (OFF)	25°C	0.01	0.8	0.01	0.8	0.01	
		$V_{ON/\overline{OFF}} < 0.15\text{ V}$ (OFF)	$-40^\circ\text{C} \text{ to } 105^\circ\text{C}$	0.05	2	0.05	2	0.05	
			$-40^\circ\text{C} \text{ to } 125^\circ\text{C}$		5		5		
$V_{ON/\overline{OFF}}$	ON/ $\overline{OFF}$ input voltage <sup>(2)</sup>	$V_{ON/\overline{OFF}} = \text{HIGH} \rightarrow \text{O/P ON}$	25°C	1.4		1.4		1.4	V
			$-40^\circ\text{C} \text{ to } 125^\circ\text{C}$	1.6		1.6		1.6	
		$V_{ON/\overline{OFF}} = \text{LOW} \rightarrow \text{O/P OFF}$	25°C	0.55		0.55		0.55	
			$-40^\circ\text{C} \text{ to } 125^\circ\text{C}$		0.15		0.15		
$I_{ON/\overline{OFF}}$	ON/ $\overline{OFF}$ input current	$V_{ON/\overline{OFF}} = 0$	25°C	0.01		0.01		0.01	\mu A
			$-40^\circ\text{C} \text{ to } 125^\circ\text{C}$		-2		-2		
		$V_{ON/\overline{OFF}} = 5\text{ V}$	25°C	5		5		5	
			$-40^\circ\text{C} \text{ to } 125^\circ\text{C}$		15		15		

(1) Dropout voltage is defined as the input-to-output differential at which the output voltage drops 100 mV below the value measured with a 1-V differential.

(2) The ON/ $\overline{OFF}$  input must be driven properly for reliable operation (see *Application Information*).

## Electrical Characteristics (continued)

at specified virtual junction temperature range,  $V_{IN} = V_{OUT(NOM)} + 1\text{ V}$ ,  $V_{ON/\overline{OFF}} = 2\text{ V}$ ,  $C_{IN} = 1\text{ }\mu\text{F}$ ,  $I_L = 1\text{ mA}$ ,  $C_{OUT} = 4.7\text{ }\mu\text{F}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS	$T_J$	LP2985A-xx			LP2985-xx			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
$V_n$	Output noise (RMS)  $BW = 300\text{ Hz to }50\text{ kHz}$ , $C_{OUT} = 10\text{ }\mu\text{F}$ , $C_{BYPASS} = 10\text{ nF}$	$25^\circ\text{C}$		30			30		$\mu\text{V}$
$\Delta V_{OUT}/\Delta V_{IN}$	Ripple rejection  $f = 1\text{ kHz}$ , $C_{OUT} = 10\text{ }\mu\text{F}$ , $C_{BYPASS} = 10\text{ nF}$	$25^\circ\text{C}$		45			45		$\text{dB}$
$I_{OUT(PK)}$	Peak output current  $V_{OUT} \geq V_{O(NOM)} - 5\%$	$25^\circ\text{C}$		350			350		$\text{mA}$
$I_{OUT(SC)}$	Short-circuit current  $R_L = 0$ (steady state) <sup>(3)</sup>	$25^\circ\text{C}$		400			400		$\text{mA}$

(3) See [Figure 6](#) in *Typical Performance Characteristics*.

## 6.6 Typical Characteristics

$C_{IN} = 1 \mu F$ ,  $C_{OUT} = 4.7 \mu F$ ,  $V_{IN} = V_{OUT(NOM)} + 1 V$ ,  $T_A = 25^\circ C$ , ON/OFF pin tied to  $V_{IN}$  (unless otherwise specified)

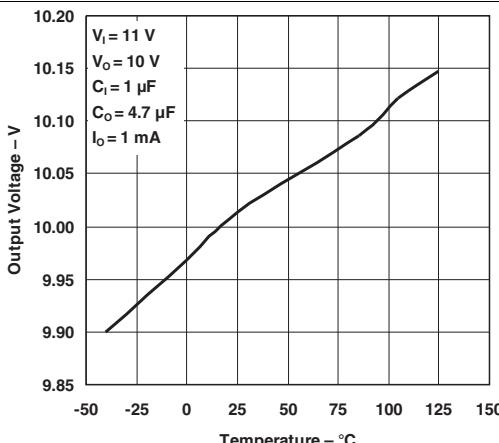


Figure 1. Output Voltage vs Temperature

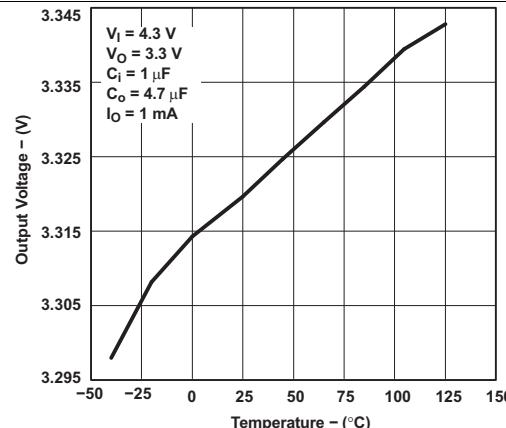


Figure 2. Output Voltage vs Temperature

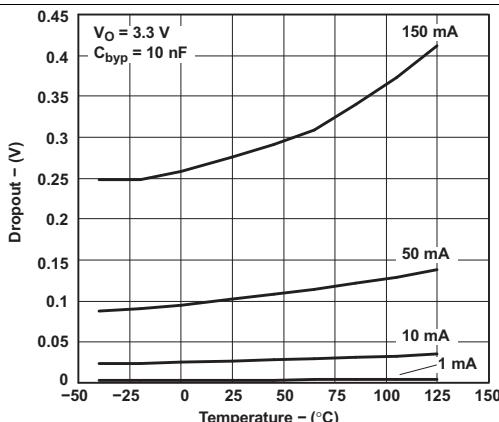


Figure 3. Dropout Voltage vs Temperature

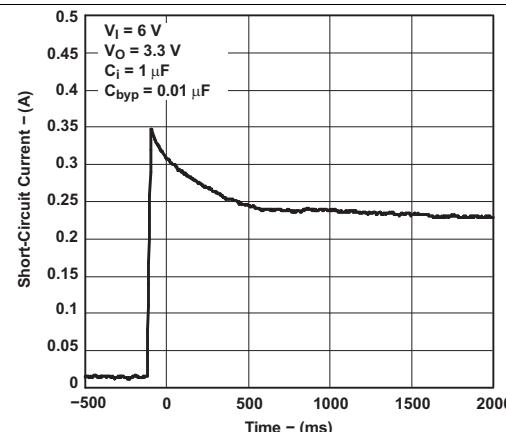


Figure 4. Short-circuit Current vs Time

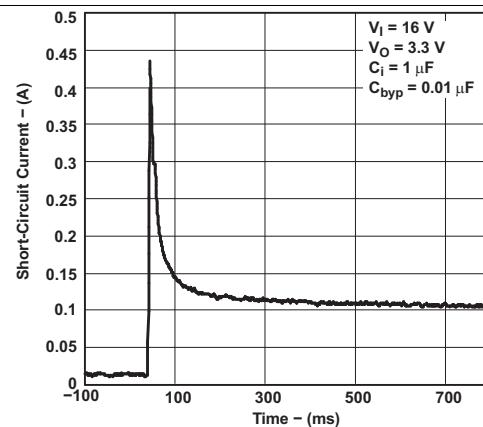


Figure 5. Short-circuit Current vs Time

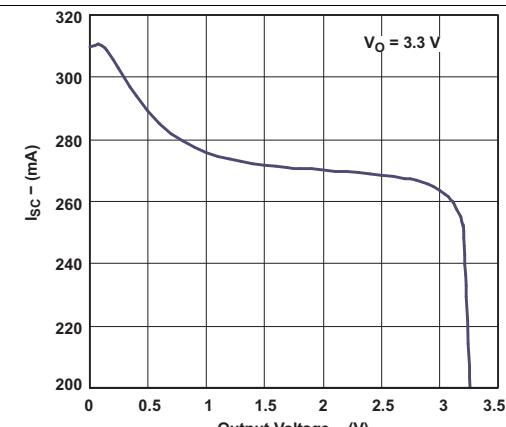


Figure 6. Short-circuit Current vs Output Voltage

## Typical Characteristics (continued)

$C_{IN} = 1 \mu F$ ,  $C_{OUT} = 4.7 \mu F$ ,  $V_{IN} = V_{OUT(NOM)} + 1 V$ ,  $T_A = 25^\circ C$ , ON/OFF pin tied to  $V_{IN}$  (unless otherwise specified)

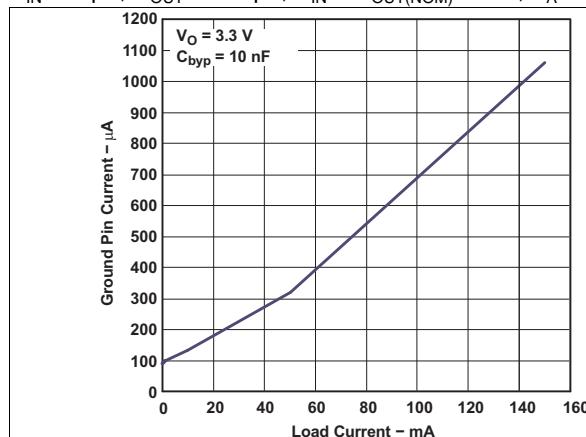


Figure 7. Ground Pin Current vs Load Current

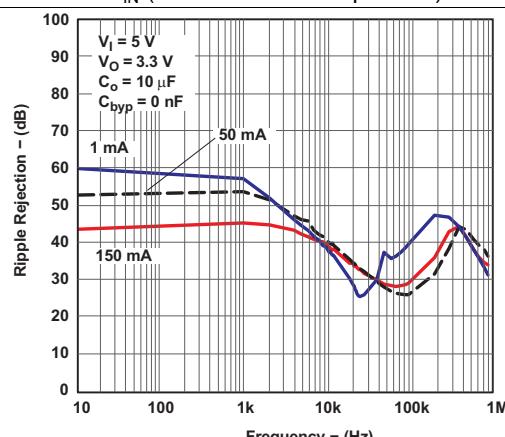


Figure 8. Ripple Rejection vs Frequency

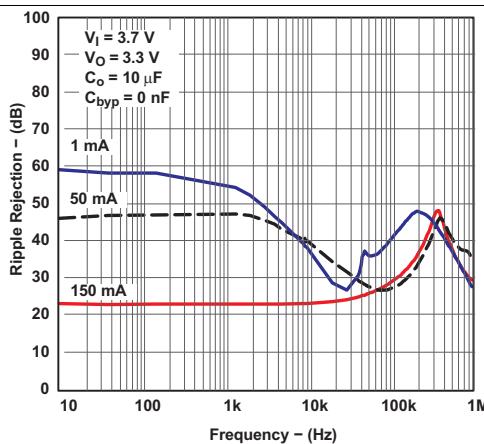


Figure 9. Ripple Rejection vs Frequency

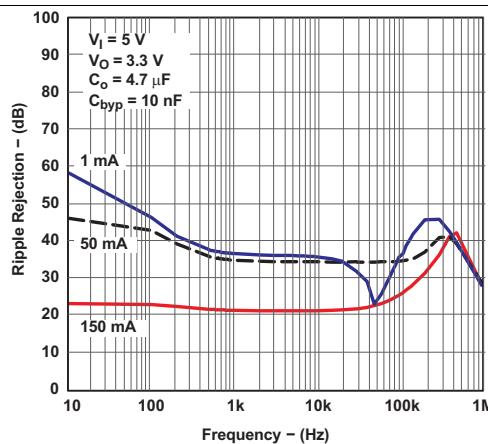


Figure 10. Ripple Rejection vs Frequency

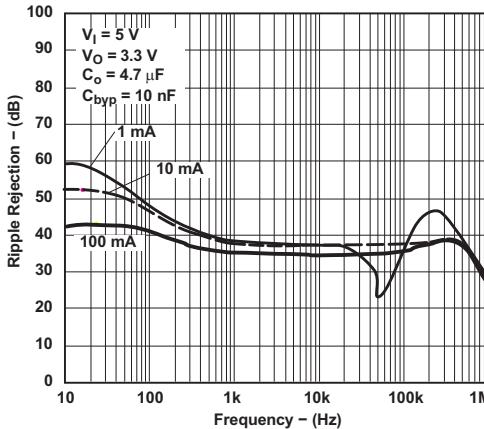


Figure 11. Ripple Rejection vs Frequency

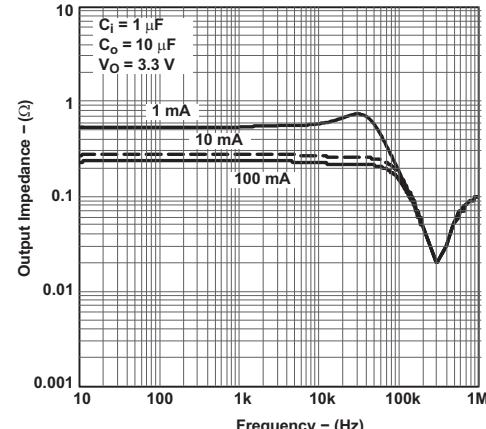


Figure 12. Output Impedance vs Frequency

## Typical Characteristics (continued)

$C_{IN} = 1 \mu\text{F}$ ,  $C_{OUT} = 4.7 \mu\text{F}$ ,  $V_{IN} = V_{OUT(NOM)} + 1 \text{ V}$ ,  $T_A = 25^\circ\text{C}$ , ON/OFF pin tied to  $V_{IN}$  (unless otherwise specified)

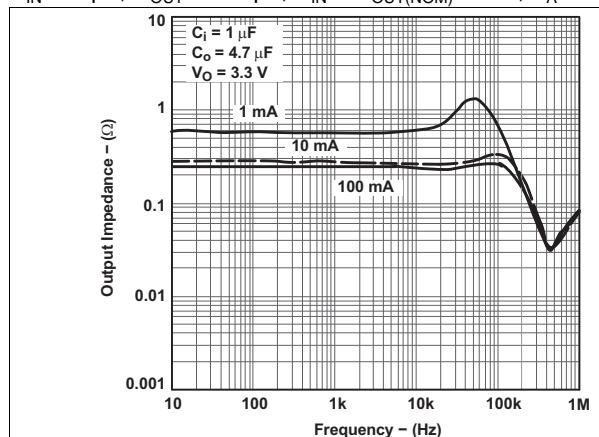


Figure 13. Output Impedance vs Frequency

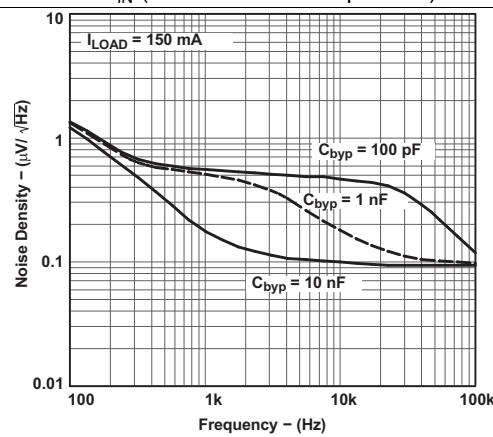


Figure 14. Output Noise Density vs Frequency

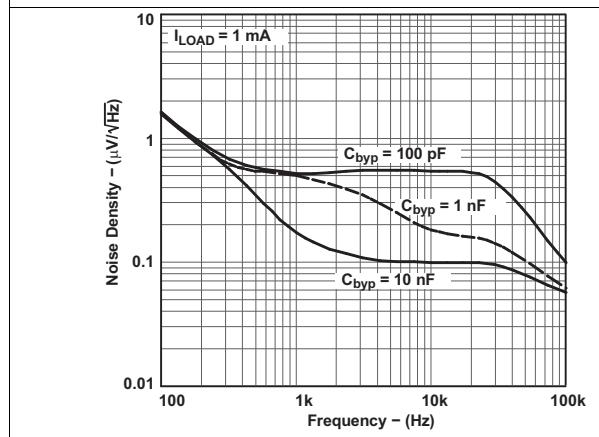


Figure 15. Output Noise Density vs Frequency

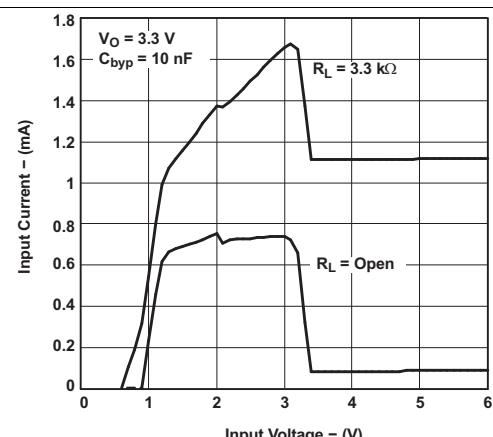


Figure 16. Input Current vs Input Voltage

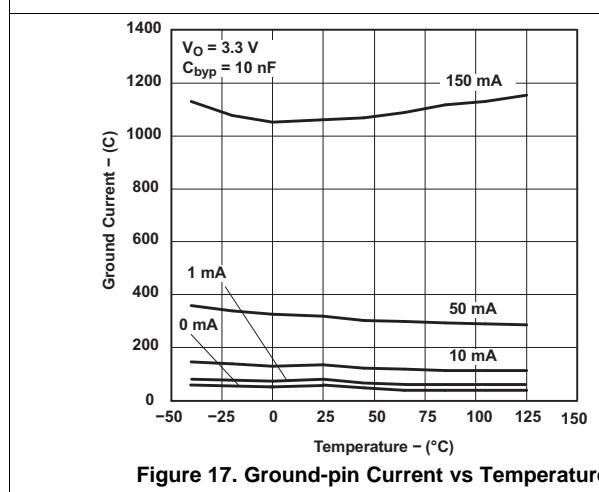


Figure 17. Ground-pin Current vs Temperature

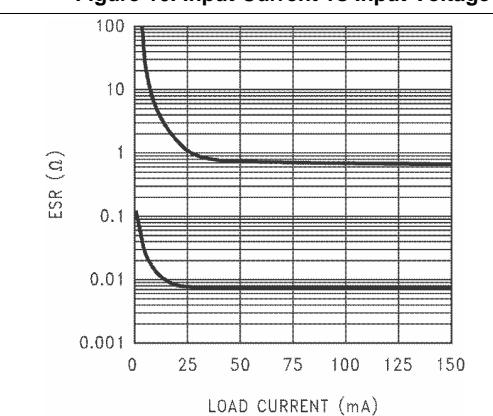
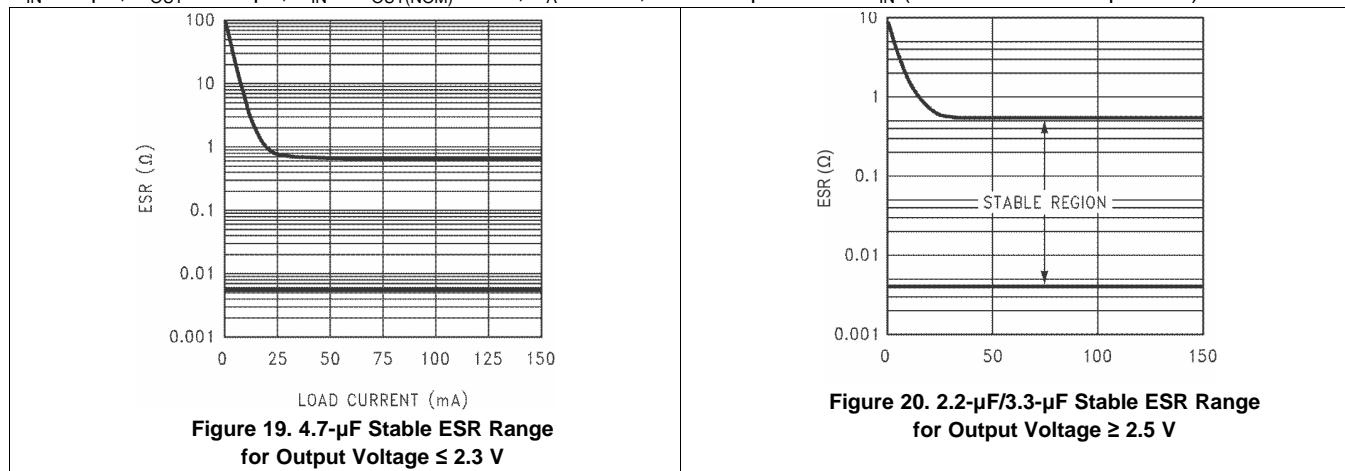


Figure 18. 2.2-μF Stable ESR Range for Output Voltage  $\leq 2.3 \text{ V}$

## Typical Characteristics (continued)

$C_{IN} = 1 \mu F$ ,  $C_{OUT} = 4.7 \mu F$ ,  $V_{IN} = V_{OUT(NOM)} + 1 V$ ,  $T_A = 25^\circ C$ , ON/OFF pin tied to  $V_{IN}$  (unless otherwise specified)

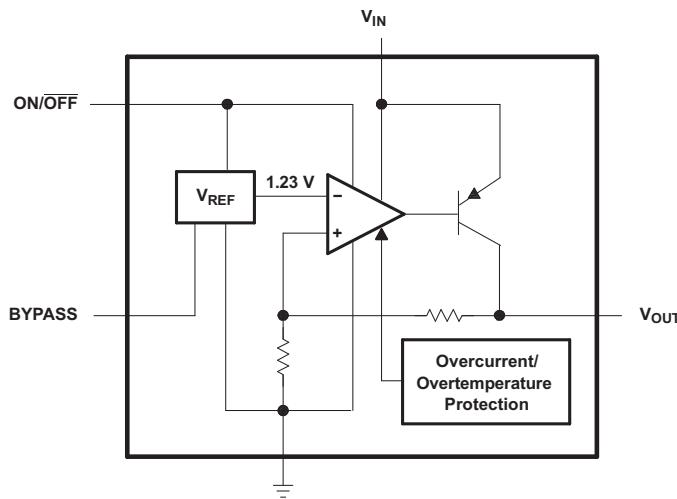


## 7 Detailed Description

### 7.1 Overview

The LP2985 family of fixed-output, low-dropout regulators offers exceptional, cost-effective performance for both portable and nonportable applications. Available in voltages of 1.8 V, 2.5 V, 2.8 V, 2.9 V, 3 V, 3.1 V, 3.3 V, 5 V, and 10 V, the family has an output tolerance of 1% for the A version (1.5% for the non-A version) and is capable of delivering 150-mA continuous load current. Standard regulator features, such as overcurrent and overtemperature protection, are included.

### 7.2 Functional Block Diagram



### 7.3 Feature Description

The LP2985 has a host of features that make the regulator an ideal candidate for a variety of portable applications:

- Low dropout: A PNP pass element allows a typical dropout of 280 mV at 150-mA load current and 7 mV at 1-mA load.
- Low quiescent current: The use of a vertical PNP process allows for quiescent currents that are considerably lower than those associated with traditional lateral PNP regulators.
- Shutdown: A shutdown feature is available, allowing the regulator to consume only 0.01  $\mu$ A when the ON/OFF pin is pulled low.
- Low-ESR-capacitor friendly: The regulator is stable with low-ESR capacitors, allowing the use of small, inexpensive, ceramic capacitors in cost-sensitive applications.
- Low noise: A BYPASS pin allows for low-noise operation, with a typical output noise of 30  $\mu$ V<sub>RMS</sub>, with the use of a 10-nF bypass capacitor.
- Small packaging: For the most space-constrained needs, the regulator is available in the SOT-23 package.

### 7.4 Device Functional Modes

#### 7.4.1 Normal Operation

In normal operation, the device will output a fixed voltage corresponding with the orderable part number. The device can deliver 150 mA of continuous load current.

#### 7.4.2 Shutdown Mode

Set the ON/OFF pin low to shut down the device when  $V_{IN}$  is still present. If a shutdown mode is not needed, tie the pin to  $V_{IN}$ . For proper operation, do not leave ON/OFF unconnected, and apply a signal with a slew rate of  $\geq 40$  mV/ $\mu$ s.

## 8 Application and Implementation

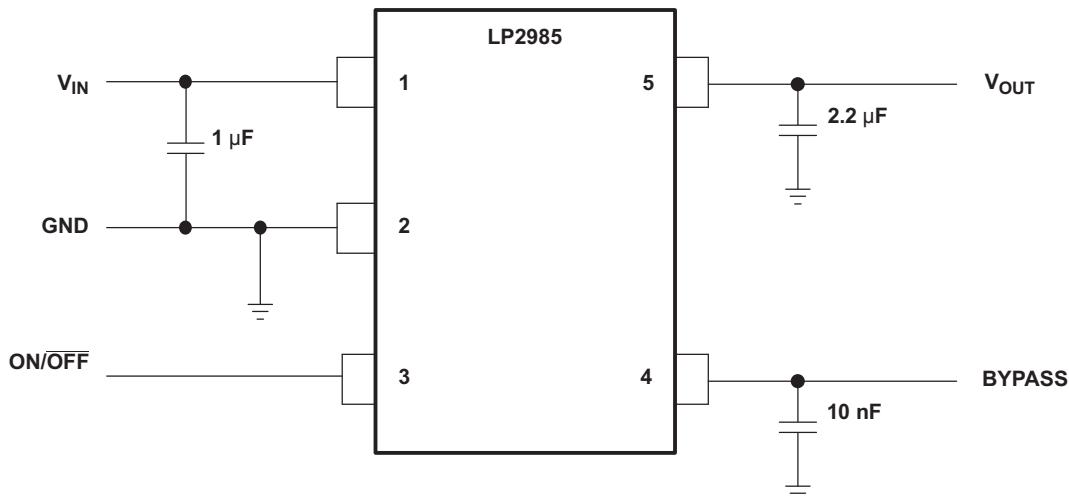
### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 8.1 Application Information

The following application schematic shows the standard usage of the LP2985 as a low-dropout regulator.

#### 8.1.1 Typical Application



#### 8.1.2 Design Requirements

Minimum C<sub>OUT</sub> value for stability (can be increased without limit for improved stability and transient response)

ON/OFF must be actively terminated. Connect to V<sub>IN</sub> if shutdown feature is not used.

Optional BYPASS capacitor for low-noise operation

#### 8.1.3 Capacitors

##### 8.1.3.1 Input Capacitor (C<sub>IN</sub>)

A minimum value of 1 μF (over the entire operating temperature range) is required at the input of the LP2985. In addition, this input capacitor should be located within 1 cm of the input pin and connected to a clean analog ground. There are no equivalent series resistance (ESR) requirements for this capacitor, and the capacitance can be increased without limit.

## Application Information (continued)

### 8.1.3.2 Output Capacitor ( $C_{OUT}$ )

As an advantage over other regulators, the LP2985 permits the use of low-ESR capacitors at the output, including ceramic capacitors that can have an ESR as low as  $5\text{ m}\Omega$ . Tantalum and film capacitors also can be used if size and cost are not issues. The output capacitor also should be located within 1 cm of the output pin and be returned to a clean analog ground.

As with other PNP LDOs, stability conditions require the output capacitor to have a minimum capacitance and an ESR that falls within a certain range.

- Minimum  $C_{OUT}$ :  $2.2\text{ }\mu\text{F}$  (can be increased without limit to improve transient response stability margin)
- ESR range: see [Figure 18](#) through [Figure 20](#)

It is critical that both the minimum capacitance and ESR requirement be met over the *entire operating temperature range*. Depending on the type of capacitors used, both these parameters can vary significantly with temperature (see *capacitor characteristics*).

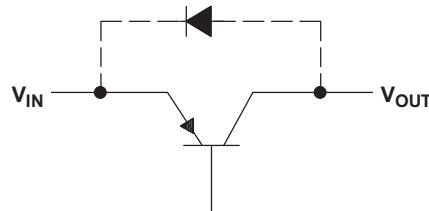
### 8.1.3.3 Noise Bypass Capacitor ( $C_{BYPASS}$ )

The LP2985 allows for low-noise performance with the use of a bypass capacitor that is connected to the internal bandgap reference via the BYPASS pin. This high-impedance bandgap circuitry is biased in the microampere range and, thus, cannot be loaded significantly; otherwise, its output – and, correspondingly, the output of the regulator – changes. Thus, for best output accuracy, dc leakage current through  $C_{BYPASS}$  should be minimized as much as possible and never should exceed  $100\text{ nA}$ .

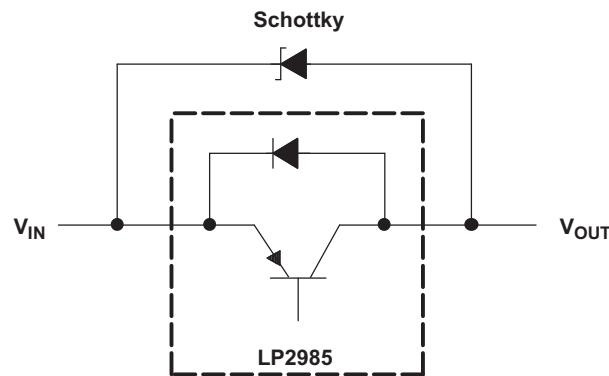
A  $10\text{-nF}$  capacitor is recommended for  $C_{BYPASS}$ . Ceramic and film capacitors are well suited for this purpose.

### 8.1.3.4 Reverse Input-Output Voltage

There is an inherent diode present across the PNP pass element of the LP2985.



With the anode connected to the output, this diode is reverse biased during normal operation, since the input voltage is higher than the output. However, if the output is pulled higher than the input for any reason, this diode is forward biased and can cause a parasitic silicon-controlled rectifier (SCR) to latch, resulting in high current flowing from the output to the input. Thus, to prevent possible damage to the regulator in any application where the output may be pulled above the input, or the input may be shorted to ground, an external Schottky diode should be connected between the output and input. With the anode on output, this Schottky limits the reverse voltage across the output and input pins to  $\sim 0.3\text{ V}$ , preventing the regulator's internal diode from forward biasing.



## Application Information (continued)

### 8.1.4 Detailed Design Procedure

#### 8.1.4.1 Capacitor Characteristics

##### 8.1.4.1.1 Ceramics

Ceramic capacitors are ideal choices for use on the output of the LP2985 for several reasons. For capacitances in the range of 2.2  $\mu\text{F}$  to 4.7  $\mu\text{F}$ , ceramic capacitors have the lowest cost and the lowest ESR, making them choice candidates for filtering high-frequency noise. For instance, a typical 2.2- $\mu\text{F}$  ceramic capacitor has an ESR in the range of 10 m $\Omega$  to 20 m $\Omega$  and, thus, satisfies minimum ESR requirements of the regulator.

Ceramic capacitors have one major disadvantage that must be taken into account – a poor temperature coefficient, where the capacitance can vary significantly with temperature. For instance, a large-value ceramic capacitor ( $\geq 2.2 \mu\text{F}$ ) can lose more than half of its capacitance as the temperature rises from 25°C to 85°C. Thus, a 2.2- $\mu\text{F}$  capacitor at 25°C drops well below the minimum  $C_{\text{OUT}}$  required for stability, as ambient temperature rises. For this reason, select an output capacitor that maintains the minimum 2.2  $\mu\text{F}$  required for stability over the entire operating temperature range. Note that there are some ceramic capacitors that can maintain a  $\pm 15\%$  capacitance tolerance over temperature.

##### 8.1.4.1.2 Tantalum

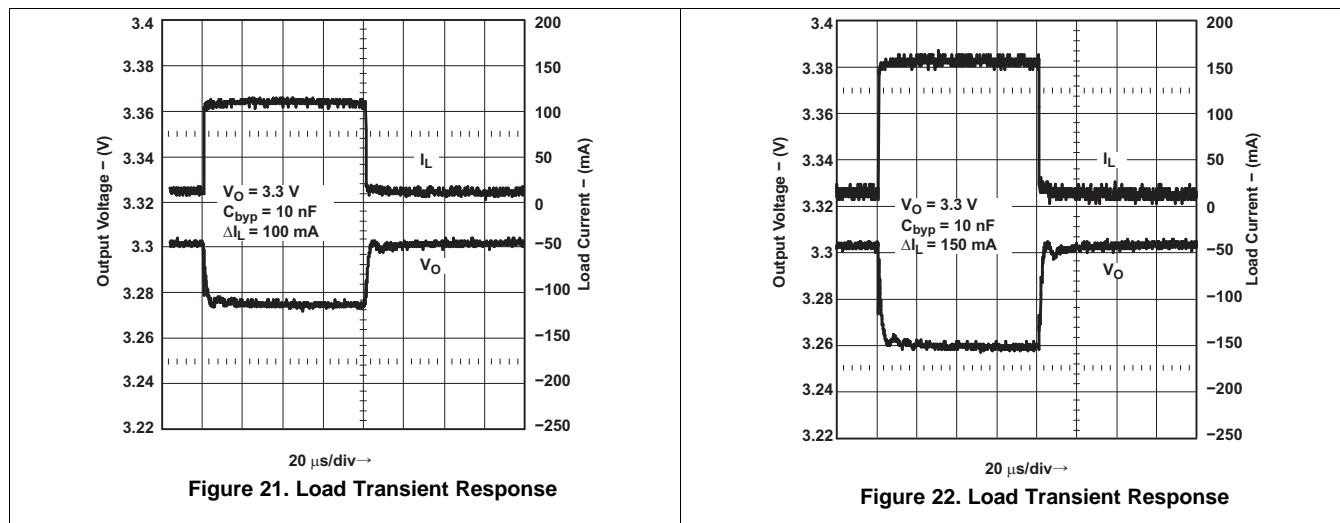
Tantalum capacitors can be used at the output of the LP2985, but there are significant disadvantages that could prohibit their use:

- In the 1- $\mu\text{F}$  to 4.7- $\mu\text{F}$  range, tantalum capacitors are more expensive than ceramics of the equivalent capacitance and voltage ratings.
- Tantalum capacitors have higher ESRs than their equivalent-sized ceramic counterparts. Thus, to meet the ESR requirements, a higher-capacitance tantalum may be required, at the expense of larger size and higher cost.
- The ESR of a tantalum capacitor increases as temperature drops, as much as double from 25°C to -40°C. Thus, ESR margins must be maintained over the temperature range to prevent regulator instability.

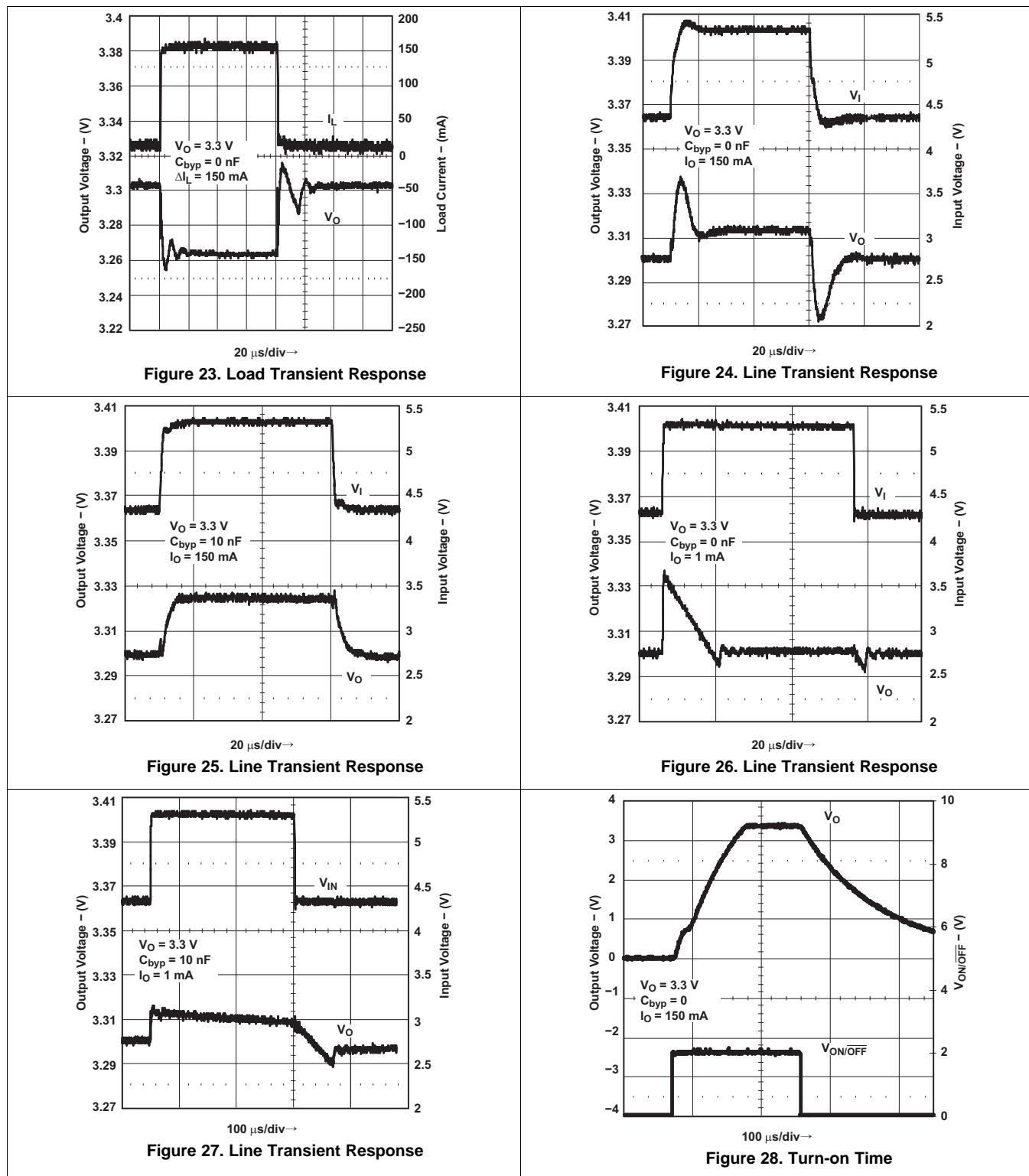
#### 8.1.4.2 ON/OFF Operation

The LP2985 allows for a shutdown mode via the ON/OFF pin. Driving the pin LOW ( $\leq 0.3$  V) turns the device OFF; conversely, a HIGH ( $\geq 1.6$  V) turns the device ON. If the shutdown feature is not used, ON/OFF should be connected to the input to ensure that the regulator is on at all times. For proper operation, do not leave ON/OFF unconnected, and apply a signal with a slew rate of  $\geq 40 \text{ mV}/\mu\text{s}$ .

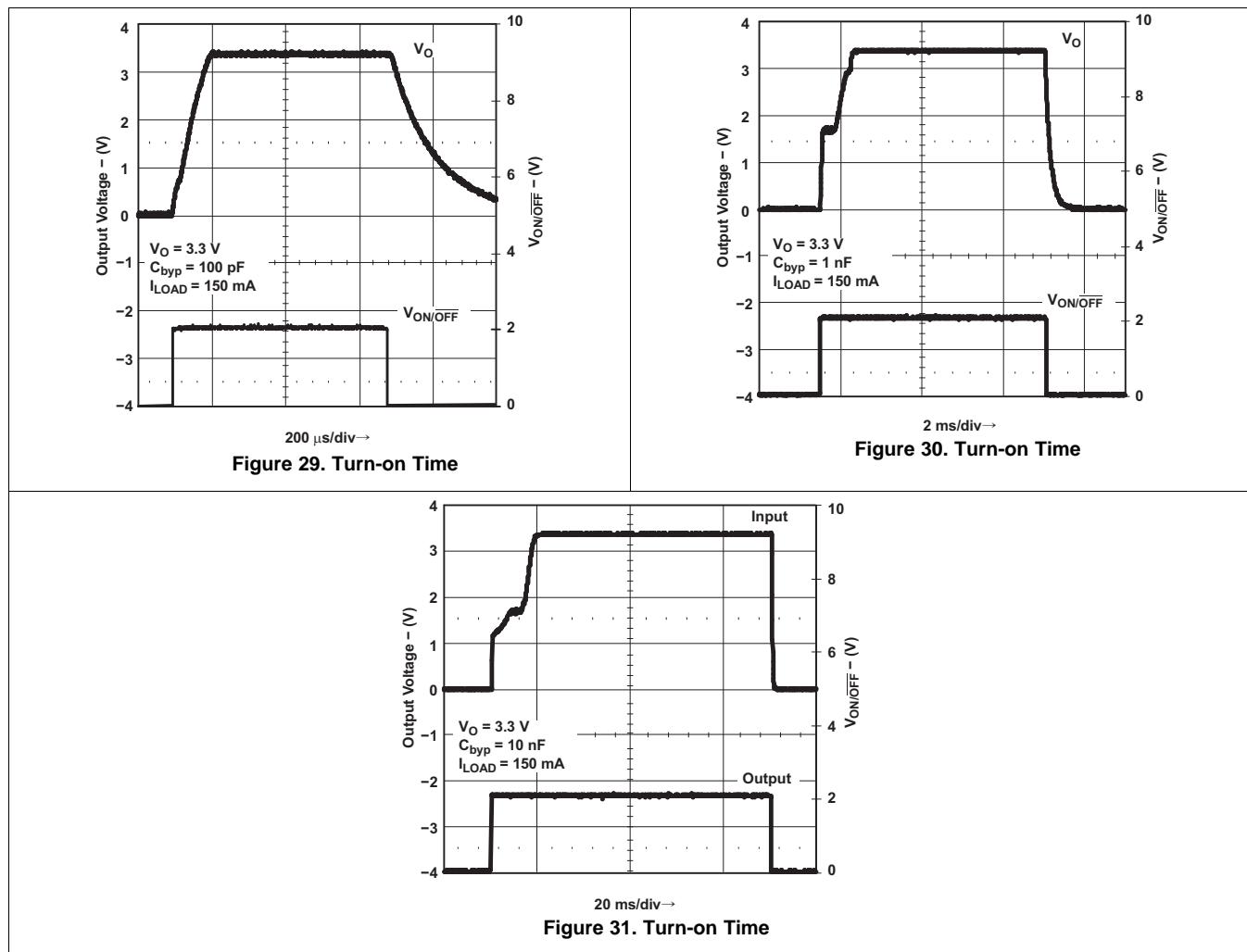
### 8.1.5 Application Curves



## Application Information (continued)



## Application Information (continued)



## 9 Power Supply Recommendations

A power supply may be used at the input voltage within the ranges given in the [Recommended Operating Conditions](#) table. It is recommended to use bypass capacitors as described in [Layout Guidelines](#).

## 10 Layout

### 10.1 Layout Guidelines

- It is recommended that the input pin be bypassed to ground with a bypass-capacitor.
- The optimum placement of the bypass capacitor is closest to the  $V_{IN}$  of the device and GND of the system. Care must be taken to minimize the loop area formed by the bypass-capacitor connection, the  $V_{IN}$  pin, and the GND pin of the system.
- For operation at full-rated load, it is recommended to use wide trace lengths to eliminate IR drop and heat dissipation.

### 10.2 Layout Example

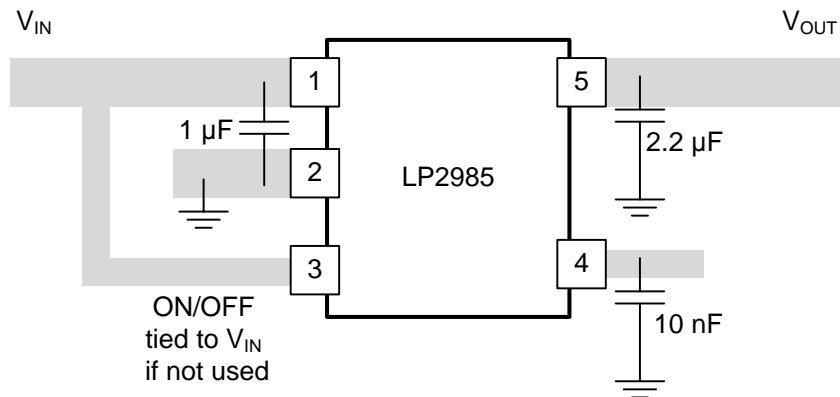


Figure 32. Layout Diagram

## 11 Device and Documentation Support

### 11.1 Trademarks

All trademarks are the property of their respective owners.

### 11.2 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 11.3 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LP2985-10DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LRCG	<span style="background-color: red; color: white;">Samples</span>
LP2985-10DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LRCG	<span style="background-color: red; color: white;">Samples</span>
LP2985-18DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU   CU SN	Level-1-260C-UNLIM	-40 to 125	(LPH3 ~ LPHG ~ LPHL)	<span style="background-color: red; color: white;">Samples</span>
LP2985-18DBVRE4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LPHG	<span style="background-color: red; color: white;">Samples</span>
LP2985-18DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LPHG	<span style="background-color: red; color: white;">Samples</span>
LP2985-18DBVVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU   CU SN	Level-1-260C-UNLIM	-40 to 125	(LPH3 ~ LPHG ~ LPHL)	<span style="background-color: red; color: white;">Samples</span>
LP2985-18DBVTE4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LPHG	<span style="background-color: red; color: white;">Samples</span>
LP2985-18DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LPHG	<span style="background-color: red; color: white;">Samples</span>
LP2985-25DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LPL3 ~ LPLG ~ LPLL)	<span style="background-color: red; color: white;">Samples</span>
LP2985-25DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LPL3 ~ LPLG ~ LPLL)	<span style="background-color: red; color: white;">Samples</span>
LP2985-25DBVVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LPL3 ~ LPLG ~ LPLL)	<span style="background-color: red; color: white;">Samples</span>
LP2985-25DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LPL3 ~ LPLG ~ LPLL)	<span style="background-color: red; color: white;">Samples</span>
LP2985-28DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU   CU SN	Level-1-260C-UNLIM	-40 to 125	(LPG3 ~ LPGG ~ LPGL)	<span style="background-color: red; color: white;">Samples</span>
LP2985-28DBVVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU   CU SN	Level-1-260C-UNLIM	-40 to 125	(LPG3 ~ LPGG ~ LPGL)	<span style="background-color: red; color: white;">Samples</span>
LP2985-28DBVTE4	ACTIVE	SOT-23	DBV	5		TBD	Call TI	Call TI	-40 to 125		<span style="background-color: red; color: white;">Samples</span>
LP2985-28DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LPGG	<span style="background-color: red; color: white;">Samples</span>
LP2985-29DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LPM3 ~ LPMG ~ LPML)	<span style="background-color: red; color: white;">Samples</span>

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LP2985-30DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LPN3 ~ LPNG ~ LPNL)	<b>Samples</b>
LP2985-30DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LPN3 ~ LPNG ~ LPNL)	<b>Samples</b>
LP2985-30DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LPN3 ~ LPNG ~ LPNL)	<b>Samples</b>
LP2985-30DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LPN3 ~ LPNG ~ LPNL)	<b>Samples</b>
LP2985-33DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LPF3 ~ LPFG ~ LPFL)	<b>Samples</b>
LP2985-33DBVRE4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LPFG	<b>Samples</b>
LP2985-33DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LPFG	<b>Samples</b>
LP2985-33DBVTT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU   CU SN	Level-1-260C-UNLIM	-40 to 125	(LPF3 ~ LPFG ~ LPFL)	<b>Samples</b>
LP2985-33DBVTE4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LPFG	<b>Samples</b>
LP2985-33DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LPFG	<b>Samples</b>
LP2985-50DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LPS3 ~ LPSG ~ LPSL)	<b>Samples</b>
LP2985-50DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LPS3 ~ LPSG ~ LPSL)	<b>Samples</b>
LP2985-50DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LPS3 ~ LPSG ~ LPSL)	<b>Samples</b>
LP2985-50DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LPS3 ~ LPSG ~ LPSL)	<b>Samples</b>
LP2985A-10DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LRDG	<b>Samples</b>
LP2985A-10DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LRDG	<b>Samples</b>
LP2985A-18DBVJ	ACTIVE	SOT-23	DBV	5	10000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LPTL	<b>Samples</b>
LP2985A-18DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU   CU SN	Level-1-260C-UNLIM	-40 to 125	(LPT3 ~ LPTG ~ LPTL)	<b>Samples</b>

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LP2985A-18DBVRE4	ACTIVE	SOT-23	DBV	5		TBD	Call TI	Call TI	-40 to 125		<span style="background-color: red; color: white;">Samples</span>
LP2985A-18DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LPTG	<span style="background-color: red; color: white;">Samples</span>
LP2985A-18DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU   CU SN	Level-1-260C-UNLIM	-40 to 125	(LPT3 ~ LPTG ~ LPPL)	<span style="background-color: red; color: white;">Samples</span>
LP2985A-18DBVTE4	ACTIVE	SOT-23	DBV	5		TBD	Call TI	Call TI	-40 to 125		<span style="background-color: red; color: white;">Samples</span>
LP2985A-25DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LPU3 ~ LPUG ~ LPUL)	<span style="background-color: red; color: white;">Samples</span>
LP2985A-25DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LPU3 ~ LPUG ~ LPUL)	<span style="background-color: red; color: white;">Samples</span>
LP2985A-25DBVVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LPU3 ~ LPUG ~ LPUL)	<span style="background-color: red; color: white;">Samples</span>
LP2985A-25DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LPU3 ~ LPUG ~ LPUL)	<span style="background-color: red; color: white;">Samples</span>
LP2985A-28DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU   CU SN	Level-1-260C-UNLIM	-40 to 125	(LPJ3 ~ LPJG ~ LPJL)	<span style="background-color: red; color: white;">Samples</span>
LP2985A-28DBVVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU   CU SN	Level-1-260C-UNLIM	-40 to 125	(LPJ3 ~ LPJG ~ LPJL)	<span style="background-color: red; color: white;">Samples</span>
LP2985A-29DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LPZ3 ~ LPZG ~ LPZL)	<span style="background-color: red; color: white;">Samples</span>
LP2985A-30DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LR3 ~ LRAG ~ LRAL)	<span style="background-color: red; color: white;">Samples</span>
LP2985A-30DBVVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LR3 ~ LRAG ~ LRAL)	<span style="background-color: red; color: white;">Samples</span>
LP2985A-30DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LR3 ~ LRAG ~ LRAL)	<span style="background-color: red; color: white;">Samples</span>
LP2985A-33DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU   CU SN	Level-1-260C-UNLIM	-40 to 125	(LPK3 ~ LPKG ~ LPKL)	<span style="background-color: red; color: white;">Samples</span>
LP2985A-33DBVRE4	ACTIVE	SOT-23	DBV	5		TBD	Call TI	Call TI	-40 to 125		<span style="background-color: red; color: white;">Samples</span>
LP2985A-33DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LPKG	<span style="background-color: red; color: white;">Samples</span>
LP2985A-33DBVVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU   CU SN	Level-1-260C-UNLIM	-40 to 125	(LPK3 ~ LPKG ~ LPKL)	<span style="background-color: red; color: white;">Samples</span>

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LP2985A-33DBVTE4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LPKG	<span style="background-color: red; color: white;">Samples</span>
LP2985A-33DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LPKG	<span style="background-color: red; color: white;">Samples</span>
LP2985A-50DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LR13 ~ LR1G ~ LR1L)	<span style="background-color: red; color: white;">Samples</span>
LP2985A-50DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LR13 ~ LR1G ~ LR1L)	<span style="background-color: red; color: white;">Samples</span>
LP2985A-50DBVBT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LR13 ~ LR1G ~ LR1L)	<span style="background-color: red; color: white;">Samples</span>
LP2985A-50DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	(LR13 ~ LR1G ~ LR1L)	<span style="background-color: red; color: white;">Samples</span>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.



www.ti.com

## PACKAGE OPTION ADDENDUM

28-May-2015

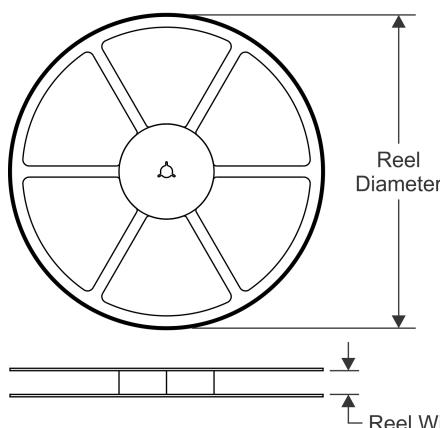
(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

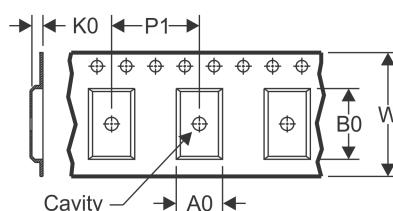
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## TAPE AND REEL INFORMATION

### REEL DIMENSIONS

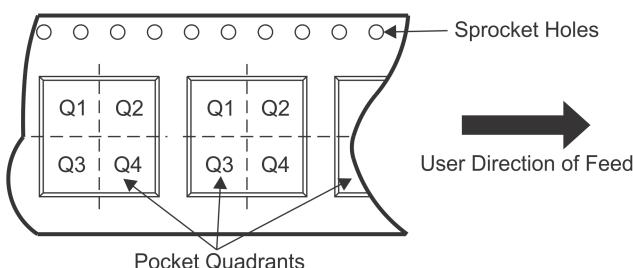


### TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

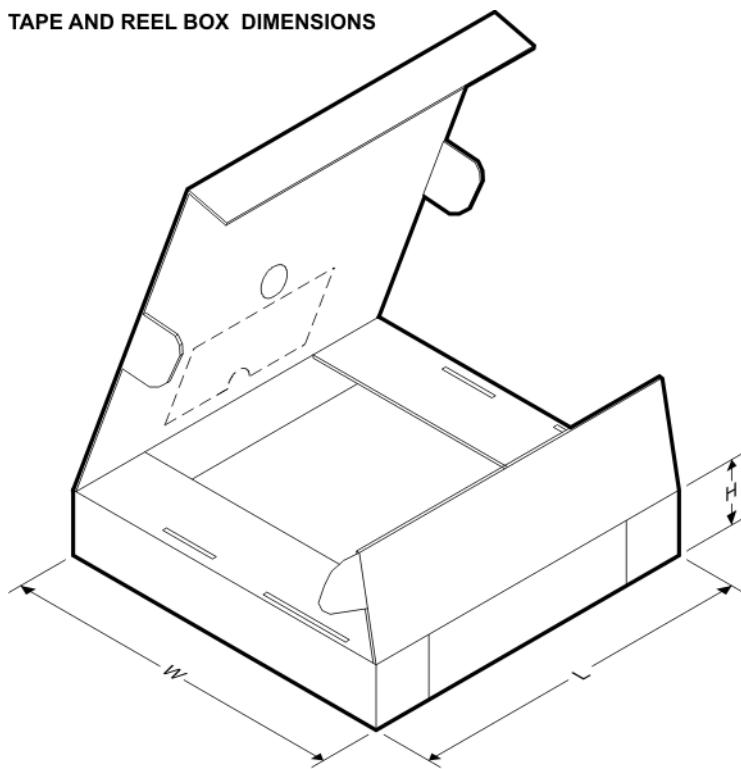
### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LP2985-10DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
LP2985-10DBVT	SOT-23	DBV	5	250	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
LP2985-18DBVR	SOT-23	DBV	5	3000	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985-18DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
LP2985-18DBVRG4	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
LP2985-18DBVT	SOT-23	DBV	5	250	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985-18DBVTG4	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
LP2985-25DBVR	SOT-23	DBV	5	3000	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985-25DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
LP2985-25DBVT	SOT-23	DBV	5	250	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985-28DBVR	SOT-23	DBV	5	3000	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985-28DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
LP2985-28DBVT	SOT-23	DBV	5	250	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985-28DBVTG4	SOT-23	DBV	5	250	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
LP2985-29DBVR	SOT-23	DBV	5	3000	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985-29DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
LP2985-30DBVR	SOT-23	DBV	5	3000	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985-30DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LP2985-30DBVT	SOT-23	DBV	5	250	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985-33DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
LP2985-33DBVRG4	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
LP2985-33DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
LP2985-33DBVTG4	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
LP2985-50DBVR	SOT-23	DBV	5	3000	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985-50DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
LP2985-50DBVT	SOT-23	DBV	5	250	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985A-10DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
LP2985A-10DBVT	SOT-23	DBV	5	250	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
LP2985A-18DBVJ	SOT-23	DBV	5	10000	330.0	8.4	3.17	3.23	1.37	4.0	8.0	Q3
LP2985A-18DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
LP2985A-18DBVR	SOT-23	DBV	5	3000	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985A-18DBVRG4	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
LP2985A-18DBVT	SOT-23	DBV	5	250	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985A-25DBVR	SOT-23	DBV	5	3000	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985A-25DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
LP2985A-25DBVT	SOT-23	DBV	5	250	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985A-28DBVR	SOT-23	DBV	5	3000	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985A-28DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
LP2985A-28DBVT	SOT-23	DBV	5	250	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985A-29DBVR	SOT-23	DBV	5	3000	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985A-29DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
LP2985A-30DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
LP2985A-30DBVR	SOT-23	DBV	5	3000	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985A-30DBVT	SOT-23	DBV	5	250	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985A-33DBVR	SOT-23	DBV	5	3000	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985A-33DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
LP2985A-33DBVRG4	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
LP2985A-33DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
LP2985A-33DBVT	SOT-23	DBV	5	250	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985A-33DBVTG4	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
LP2985A-50DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
LP2985A-50DBVR	SOT-23	DBV	5	3000	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3
LP2985A-50DBVT	SOT-23	DBV	5	250	180.0	9.2	3.17	3.23	1.37	4.0	8.0	Q3

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

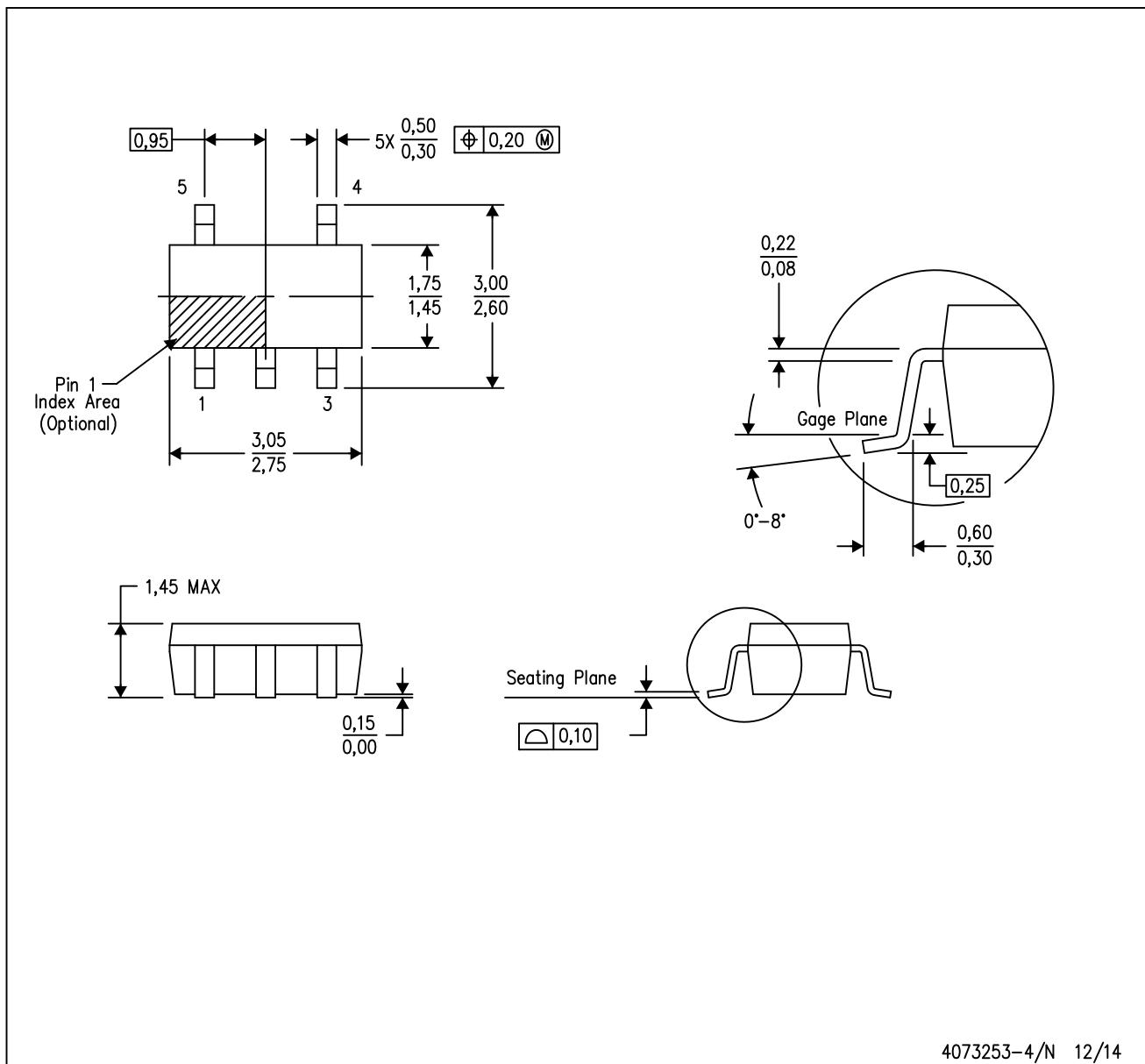
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LP2985-10DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
LP2985-10DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
LP2985-18DBVR	SOT-23	DBV	5	3000	205.0	200.0	33.0
LP2985-18DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
LP2985-18DBVRG4	SOT-23	DBV	5	3000	180.0	180.0	18.0
LP2985-18DBVT	SOT-23	DBV	5	250	205.0	200.0	33.0
LP2985-18DBVTG4	SOT-23	DBV	5	250	180.0	180.0	18.0
LP2985-25DBVR	SOT-23	DBV	5	3000	205.0	200.0	33.0
LP2985-25DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
LP2985-25DBVT	SOT-23	DBV	5	250	205.0	200.0	33.0
LP2985-28DBVR	SOT-23	DBV	5	3000	205.0	200.0	33.0
LP2985-28DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
LP2985-28DBVT	SOT-23	DBV	5	250	205.0	200.0	33.0
LP2985-28DBVTG4	SOT-23	DBV	5	250	180.0	180.0	18.0
LP2985-29DBVR	SOT-23	DBV	5	3000	205.0	200.0	33.0
LP2985-29DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
LP2985-30DBVR	SOT-23	DBV	5	3000	205.0	200.0	33.0
LP2985-30DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
LP2985-30DBVT	SOT-23	DBV	5	250	205.0	200.0	33.0
LP2985-33DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LP2985-33DBVRG4	SOT-23	DBV	5	3000	180.0	180.0	18.0
LP2985-33DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
LP2985-33DBVTG4	SOT-23	DBV	5	250	180.0	180.0	18.0
LP2985-50DBVR	SOT-23	DBV	5	3000	205.0	200.0	33.0
LP2985-50DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
LP2985-50DBVT	SOT-23	DBV	5	250	205.0	200.0	33.0
LP2985A-10DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
LP2985A-10DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
LP2985A-18DBVJ	SOT-23	DBV	5	10000	358.0	332.0	35.0
LP2985A-18DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
LP2985A-18DBVR	SOT-23	DBV	5	3000	205.0	200.0	33.0
LP2985A-18DBVRG4	SOT-23	DBV	5	3000	180.0	180.0	18.0
LP2985A-18DBVT	SOT-23	DBV	5	250	205.0	200.0	33.0
LP2985A-25DBVR	SOT-23	DBV	5	3000	205.0	200.0	33.0
LP2985A-25DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
LP2985A-25DBVT	SOT-23	DBV	5	250	205.0	200.0	33.0
LP2985A-28DBVR	SOT-23	DBV	5	3000	205.0	200.0	33.0
LP2985A-28DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
LP2985A-28DBVT	SOT-23	DBV	5	250	205.0	200.0	33.0
LP2985A-29DBVR	SOT-23	DBV	5	3000	205.0	200.0	33.0
LP2985A-29DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
LP2985A-30DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
LP2985A-30DBVR	SOT-23	DBV	5	3000	205.0	200.0	33.0
LP2985A-30DBVT	SOT-23	DBV	5	250	205.0	200.0	33.0
LP2985A-33DBVR	SOT-23	DBV	5	3000	205.0	200.0	33.0
LP2985A-33DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
LP2985A-33DBVRG4	SOT-23	DBV	5	3000	180.0	180.0	18.0
LP2985A-33DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
LP2985A-33DBVT	SOT-23	DBV	5	250	205.0	200.0	33.0
LP2985A-33DBVTG4	SOT-23	DBV	5	250	180.0	180.0	18.0
LP2985A-50DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
LP2985A-50DBVR	SOT-23	DBV	5	3000	205.0	200.0	33.0
LP2985A-50DBVT	SOT-23	DBV	5	250	205.0	200.0	33.0

## MECHANICAL DATA

DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



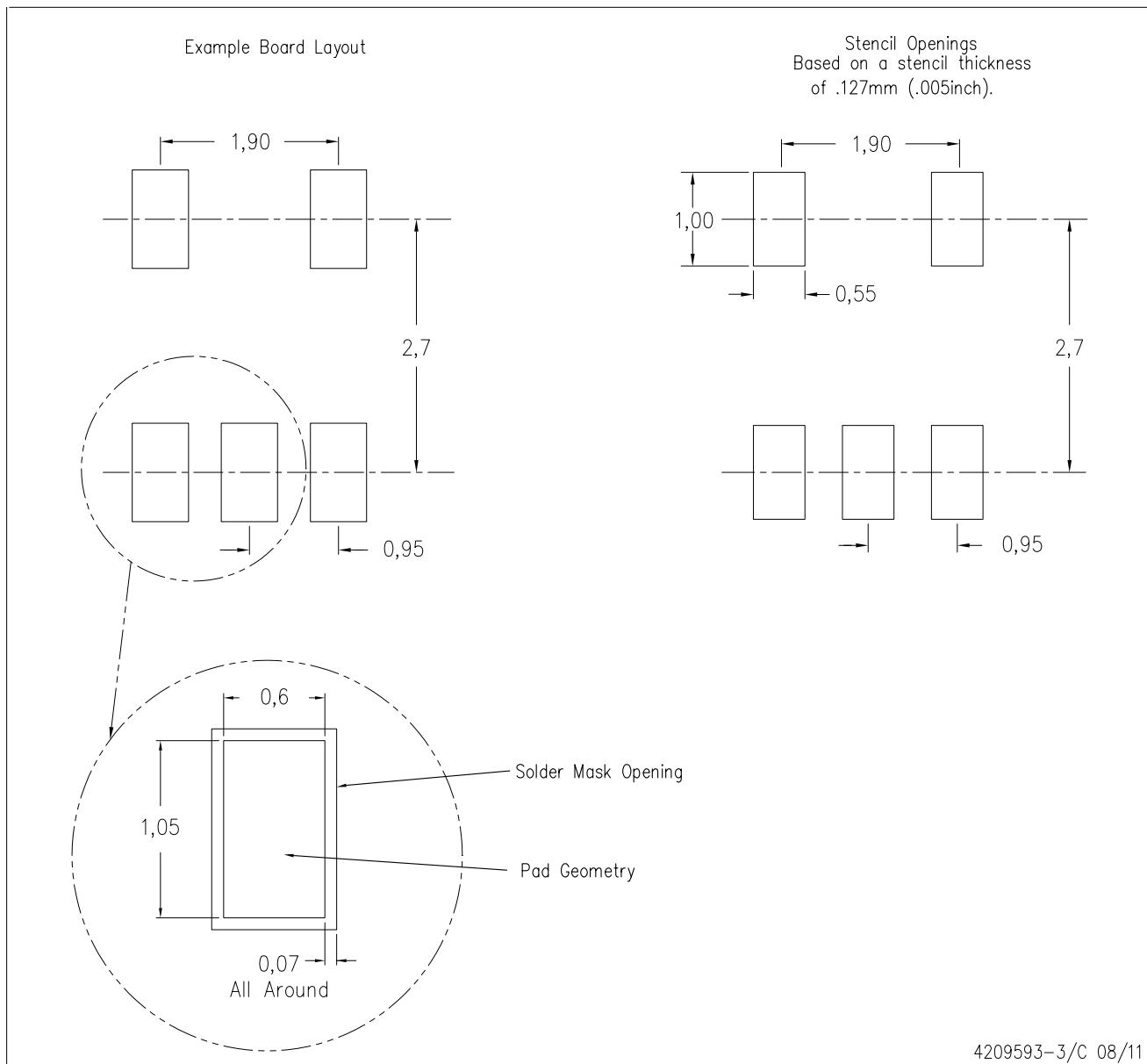
4073253-4/N 12/14

- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0,15 per side.
  - Falls within JEDEC MO-178 Variation AA.

## LAND PATTERN DATA

DBV (R-PDSO-G5)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
  - D. Publication IPC-7351 is recommended for alternate designs.
  - E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have **not** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

<b>Products</b>	<b>Applications</b>		
Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>	Automotive and Transportation	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
Amplifiers	<a href="http://amplifier.ti.com">amplifier.ti.com</a>	Communications and Telecom	<a href="http://www.ti.com/communications">www.ti.com/communications</a>
Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>	Computers and Peripherals	<a href="http://www.ti.com/computers">www.ti.com/computers</a>
DLP® Products	<a href="http://www.dlp.com">www.dlp.com</a>	Consumer Electronics	<a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>	Energy and Lighting	<a href="http://www.ti.com/energy">www.ti.com/energy</a>
Clocks and Timers	<a href="http://www.ti.com/clocks">www.ti.com/clocks</a>	Industrial	<a href="http://www.ti.com/industrial">www.ti.com/industrial</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>	Medical	<a href="http://www.ti.com/medical">www.ti.com/medical</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>	Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>	Space, Avionics and Defense	<a href="http://www.ti.com/space-avionics-defense">www.ti.com/space-avionics-defense</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>	Video and Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>
RFID	<a href="http://www.ti-rfid.com">www.ti-rfid.com</a>	<b>TI E2E Community</b>	
OMAP Applications Processors	<a href="http://www.ti.com/omap">www.ti.com/omap</a>	<a href="http://e2e.ti.com">e2e.ti.com</a>	
Wireless Connectivity	<a href="http://www.ti.com/wirelessconnectivity">www.ti.com/wirelessconnectivity</a>		